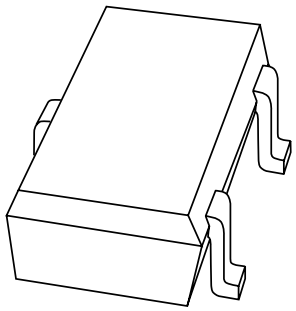
查询1PS300供应商

DATA SHEET



1PS300
High-speed double diode

Product specification
Supersedes data of 1996 Oct 04

1999 May 26

Philips
Semiconductors

PHILIPS

High-speed double diode 1PS300

FEATURES

- Very small plastic SMD package
- High switching speed: max. 4 ns
- Continuous reverse voltage: max. 80 V
- Repetitive peak reverse voltage: max. 85 V
- Repetitive peak forward current: max. 500 mA.

APPLICATIONS

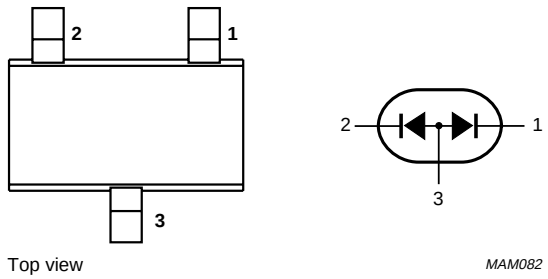
- High-speed switching in e.g. surface mounted circuits.

DESCRIPTION

The 1PS300 consists of two high-speed switching diodes with common anodes, fabricated in planar technology, and encapsulated in the very small rectangular SOT323 (SC-70) plastic SMD package.

PINNING

PIN	DESCRIPTION
1	cathode (k1)
2	cathode (k2)
3	common anode



Marking code: A3.

Fig.1 Simplified outline SOT323 (SC-70) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
V_{RRM}	repetitive peak reverse voltage		–	85	V
V_R	continuous reverse voltage		–	80	V
I_F	continuous forward current	single diode loaded; see Fig.2; note 1	–	200	mA
		double diode loaded; see Fig.2; note 1	–	170	mA
I_{FRM}	repetitive peak forward current		–	500	mA
I_{FSM}	non-repetitive peak forward current	square wave; T_j = 25 °C prior to surge			
		t = 1 μs	–	4	A
		t = 1 s	–	0.5	A
P_{tot}	total power dissipation	T_{amb} = 25 °C; note 1	–	300	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C

Note

1. Device mounted on an FR4 printed-circuit board.

ELECTRICAL CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
Per diode					
V_F	forward voltage	see Fig.3			
		I_F = 1 mA	610	–	mV
		I_F = 10 mA	740	–	mV
		I_F = 50 mA	–	1	V
		I_F = 100 mA	–	1.2	V
I_R	reverse current	see Fig.4			
		V_R = 25 V	–	30	nA
		V_R = 80 V	–	0.5	µA
		V_R = 25 V; T_j = 150 °C	–	30	µA
		V_R = 80 V; T_j = 150 °C	–	100	µA
C_d	diode capacitance	f = 1 MHz; V_R = 0; see Fig.5	–	2	pF
t_{rr}	reverse recovery time	when switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω; measured at I_R = 1 mA; see Fig.6	–	4	ns
V_{fr}	forward recovery voltage	when switched from I_F = 10 mA; t_r = 20 ns; see Fig.7	–	1.75	V

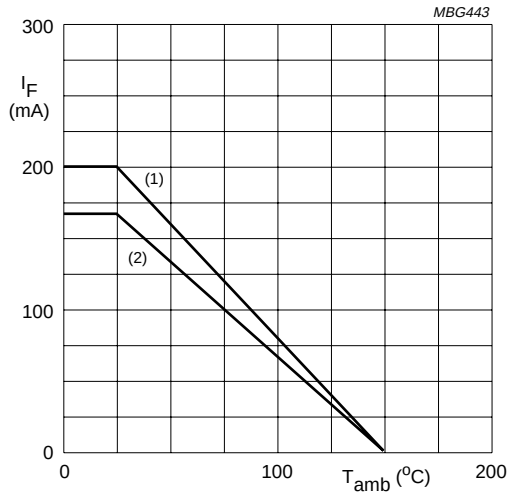
THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j\text{-}tp}$	thermal resistance from junction to tie-point		200	K/W
$R_{th\ j\text{-}a}$	thermal resistance from junction to ambient	note 1	415	K/W

Note

1. Device mounted on an FR4 printed-circuit board.

GRAPHICAL DATA

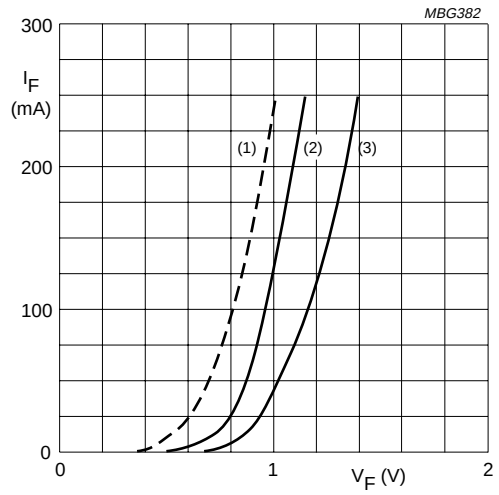


Device mounted on an FR4 printed-circuit board.

(1) Single diode loaded.

(2) Double diode loaded.

Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.

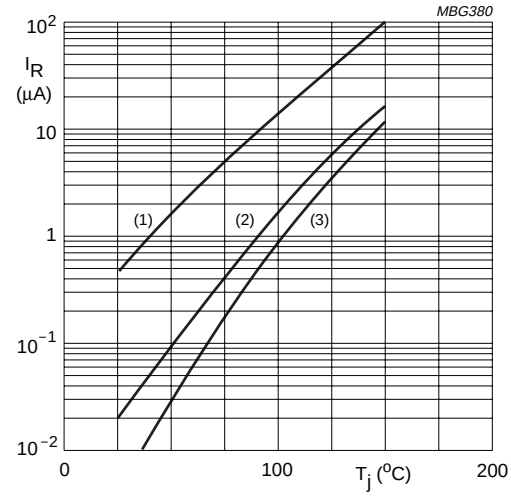


(1) T_j = 150 °C; typical values.

(2) T_j = 25 °C; typical values.

(3) T_j = 25 °C; maximum values.

Fig.3 Forward current as a function of forward voltage.

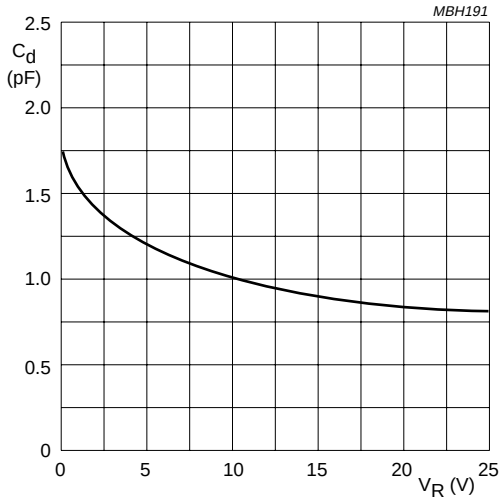


(1) V_R = 80 V; maximum values.

(2) V_R = 80 V; typical values.

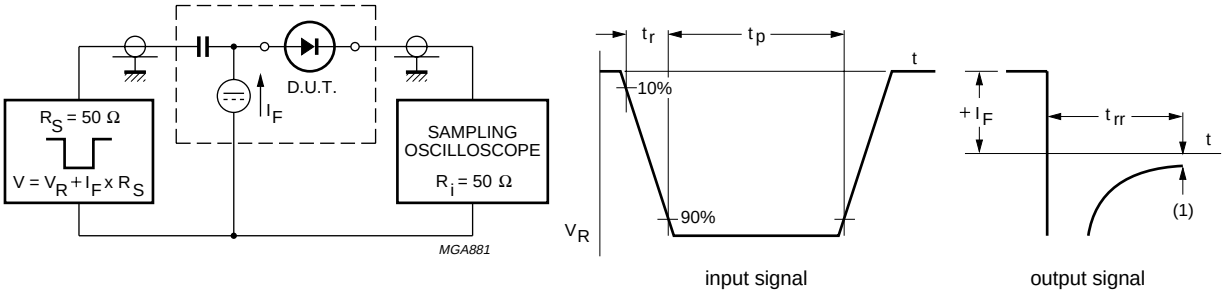
(3) V_R = 25 V; typical values.

Fig.4 Reverse current as a function of junction temperature.



f = 1 MHz; T_j = 25 °C.

Fig.5 Diode capacitance as a function of reverse voltage; typical values.



(1) I_R = 1 mA.

Fig.6 Reverse recovery voltage test circuit and waveforms.

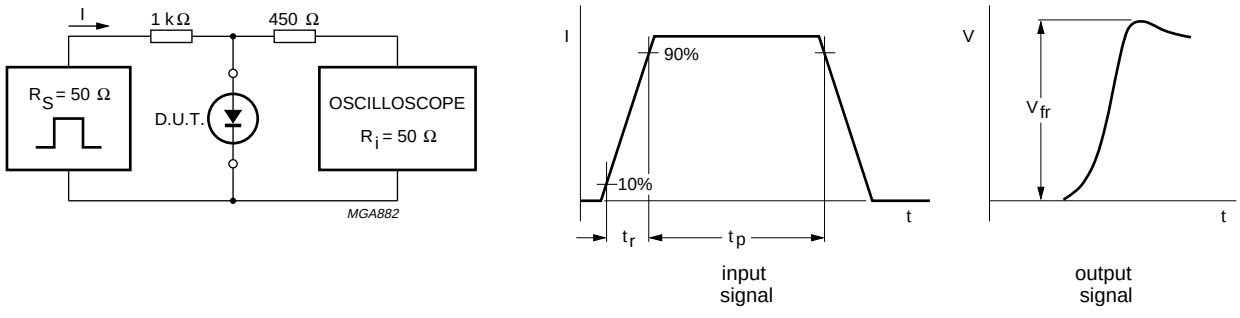
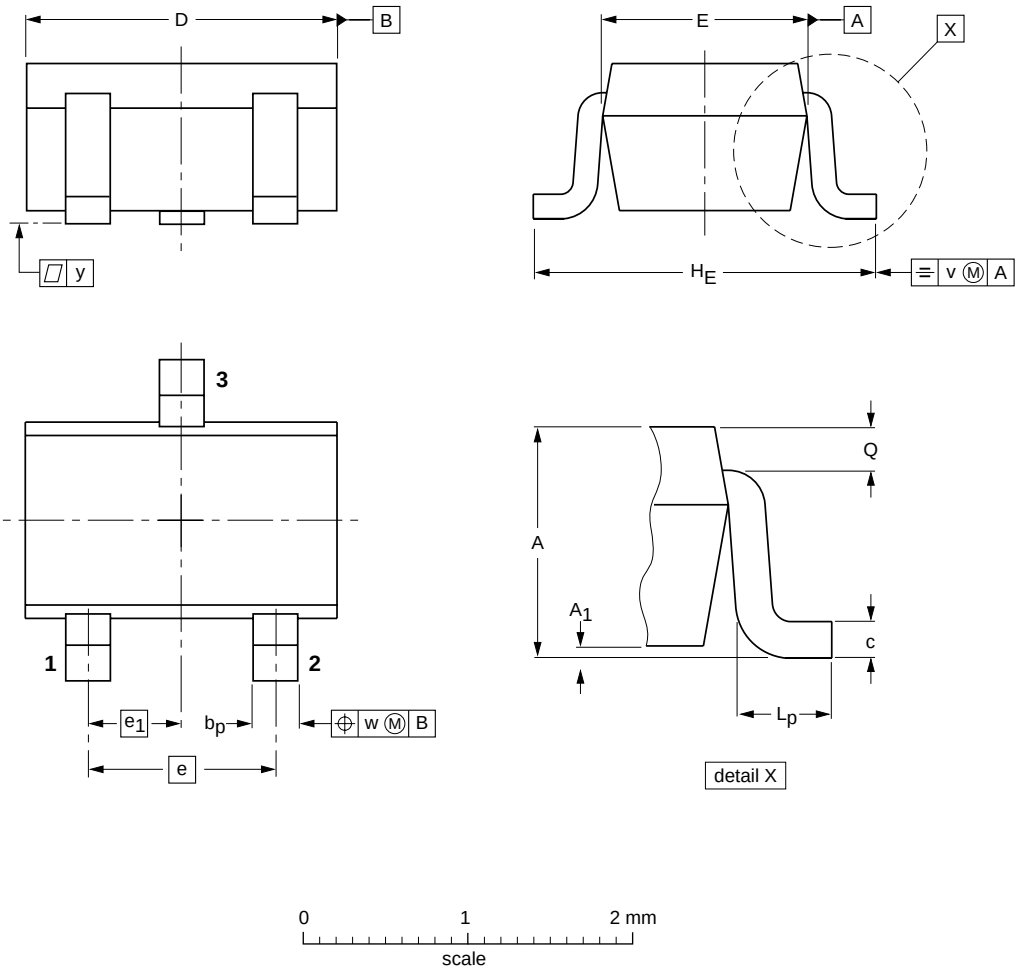


Fig.7 Forward recovery voltage test circuit and waveforms.

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads **SOT323**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1 max	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w
mm	1.1 0.8	0.1	0.4 0.3	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.23 0.13	0.2	0.2

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT323			SC-70			97-02-28

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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